

N-Ch 60V Fast Switching MOSFETs

- ★ Super Low Gate Charge
- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary

BVDSS	RDS(ON)	ID
60V	6.8mΩ	65A

Description

The SM2610E is the high cell density trenched N-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The SM2610E meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

TO252 Pin Configuration

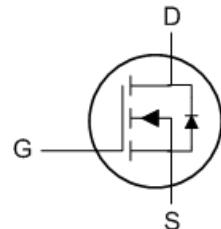
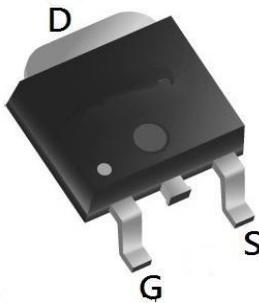


Table 1. Absolute Maximum Ratings (TA=25°C)

Symbol	Parameter	Value	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	64	V
V _{GS}	Gate-Source Voltage (V _{DS} =0V)	±20	V
I _D (DC)	Drain Current (DC) at T _c =25°C	65	A
I _D (DC)	Drain Current (DC) at T _c =100°C	45	A
I _{DM} (pulse)	Drain Current-Continuous@ Current-Pulsed ^(Note 1)	260	A
dv/dt	Peak Diode Recovery Voltage	8	V/ns
P _D	Maximum Power Dissipation(T _c =25°C)	75	W
	Derating Factor	0.5	W/°C
E _{AS}	Single Pulse Avalanche Energy ^(Note 2)	300	mJ
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 To 175	°C

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.EAS condition:T_J=25°C, V_{DD}=33V, V_G=10V

Table 2. Thermal Characteristic

Symbol	Parameter	Value	Max	Unit
$R_{\theta JC}$	Thermal Resistance,Junction-to-Case	---	2.0	°C/W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	64			V
I_{DSS}	Zero Gate Voltage Drain Current($T_c=25^\circ C$)	$V_{DS}=64V, V_{GS}=0V$			1	μA
I_{DSS}	Zero Gate Voltage Drain Current($T_c=125^\circ C$)	$V_{DS}=64V, V_{GS}=0V$			10	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=40A$		6.8	8.2	$m\Omega$
Dynamic Characteristics						
g_{FS}	Forward Transconductance	$V_{DS}=10V, I_D=15A$	15			S
C_{iss}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$		2873		pF
C_{oss}	Output Capacitance			252		pF
C_{rss}	Reverse Transfer Capacitance			205		pF
Q_g	Total Gate Charge	$V_{DS}=50V, I_D=40A, V_{GS}=10V$		56		nC
Q_{gs}	Gate-Source Charge			10		nC
Q_{gd}	Gate-Drain Charge			16		nC
Switching Times						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=30V, I_D=2A, R_L=15\Omega, V_{GS}=10V, R_G=2.5\Omega$		14.5		nS
t_r	Turn-on Rise Time			24		nS
$t_{d(off)}$	Turn-Off Delay Time			45		nS
t_f	Turn-Off Fall Time			22		nS
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current(Body Diode)			65		A
I_{SDM}	Pulsed Source-Drain Current(Body Diode)			260		A
V_{SD}	Forward On Voltage ^(Note 1)	$T_J=25^\circ C, I_{SD}=40A, V_{GS}=0V$		0.89	0.99	V
t_{rr}	Reverse Recovery Time ^(Note 1)	$T_J=25^\circ C, I_F=75A, di/dt=100A/\mu s$		22		nS
Q_{rr}	Reverse Recovery Charge ^(Note 1)			27		nC
t_{on}	Forward Turn-on Time	Intrinsic turn-on time is negligible(turn-on is dominated by L_S+L_D)				

Notes 1.Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 1.5\%$, $R_G=25\Omega$, Starting $T_J=25^\circ C$

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

Figure1. Output Characteristics

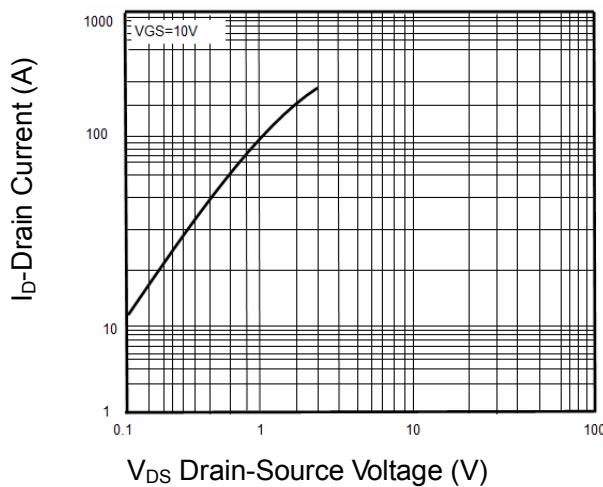


Figure2. Transfer Characteristics

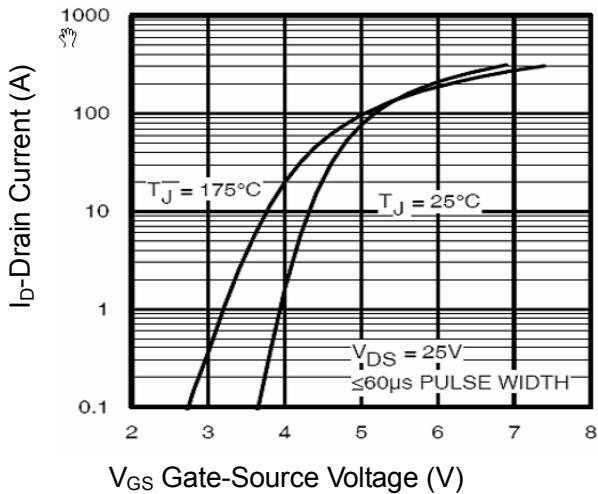


Figure3. BV_{DSS} vs Junction Temperature

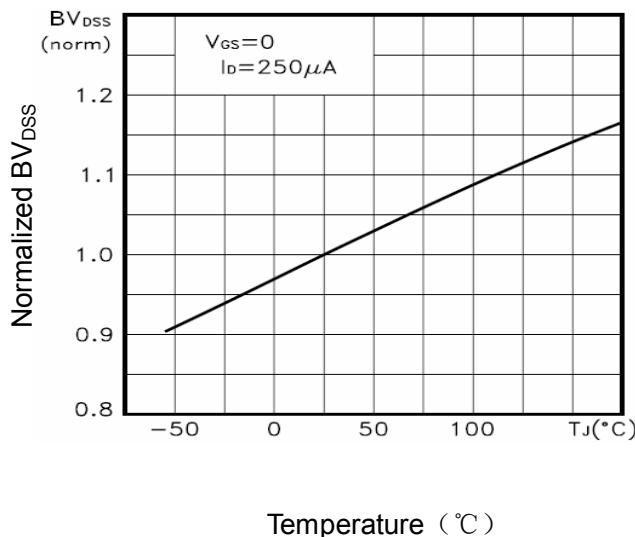


Figure4. ID vs Junction Temperature

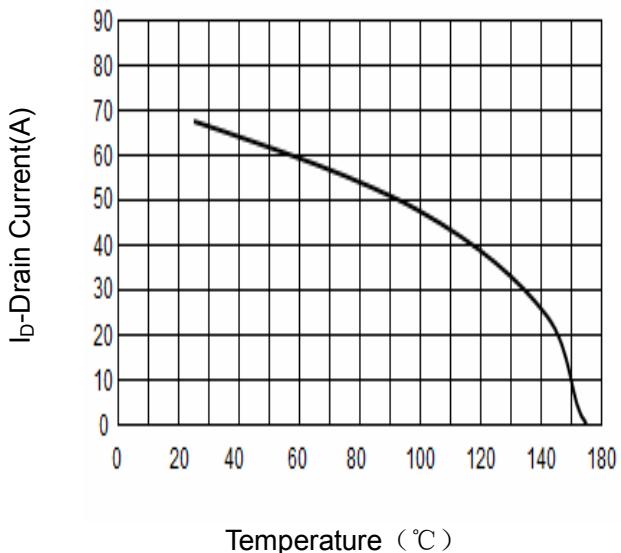


Figure5. VGS(th) vs Junction Temperature

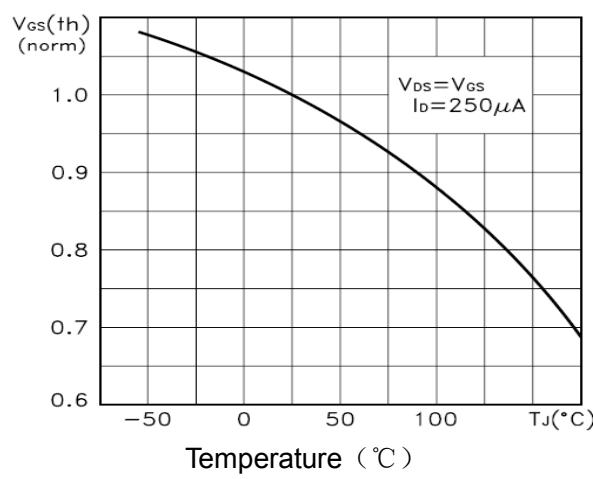


Figure6. Rdson Vs Junction Temperature

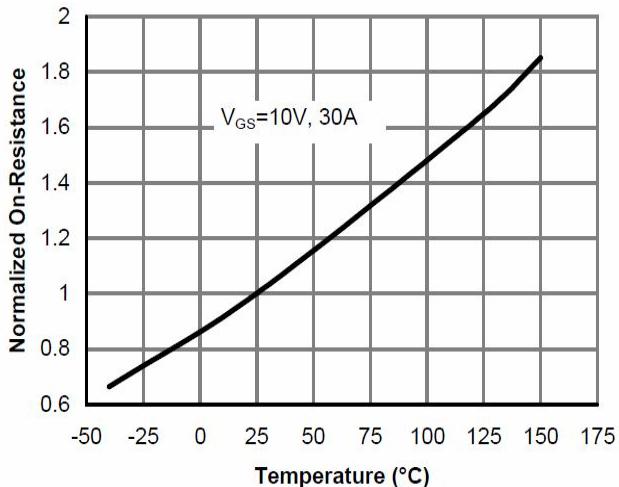
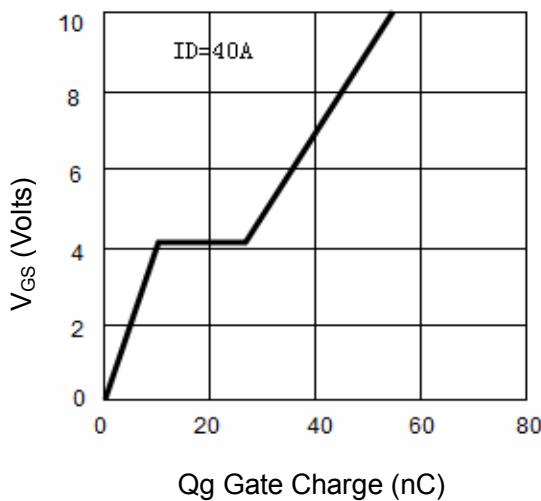
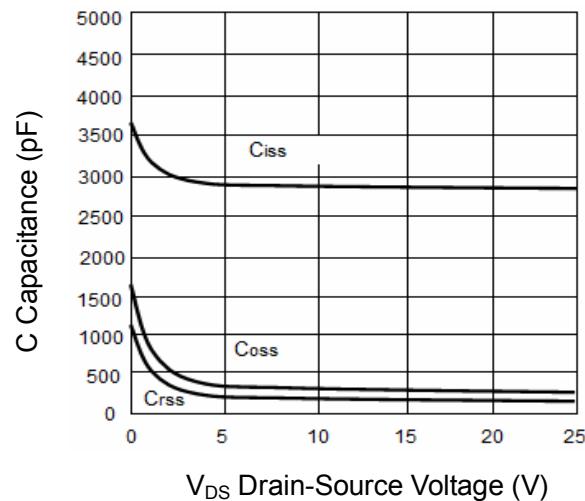
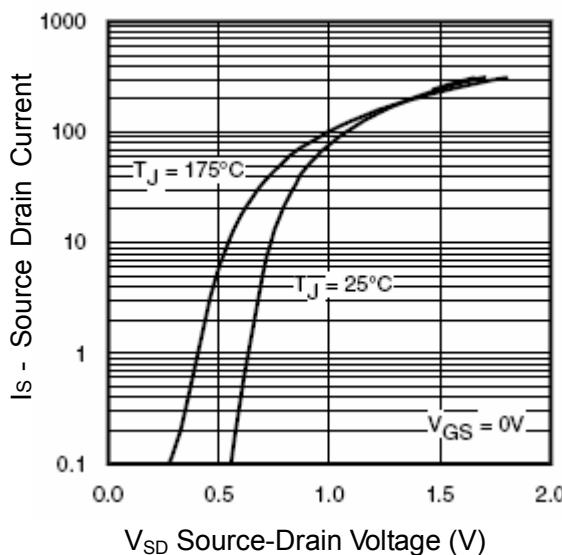
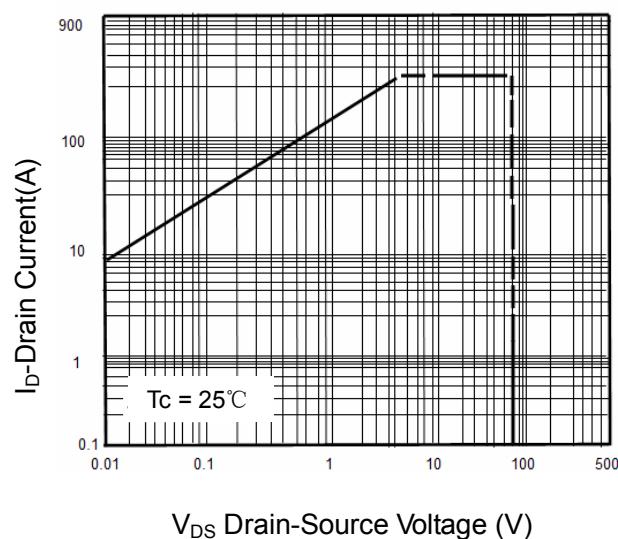
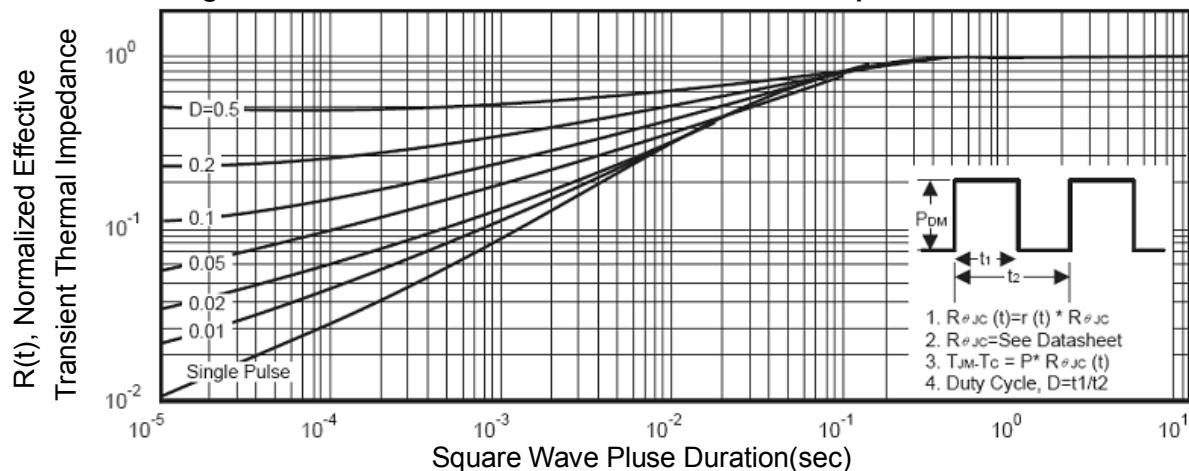
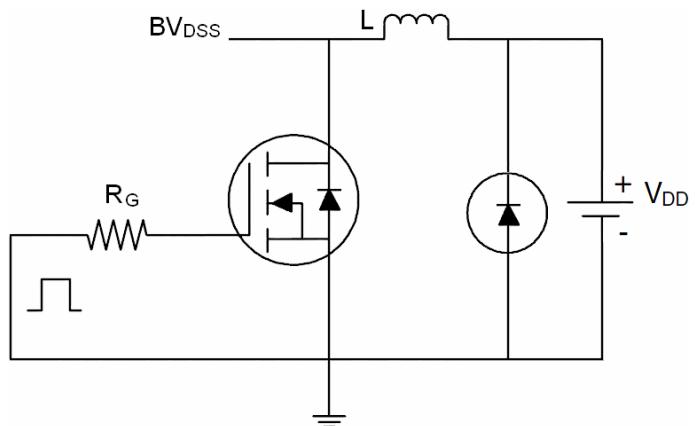
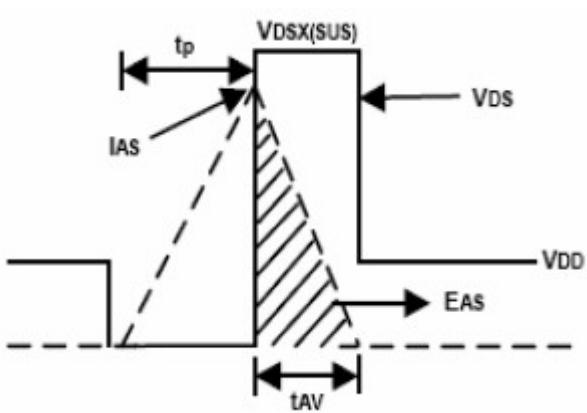


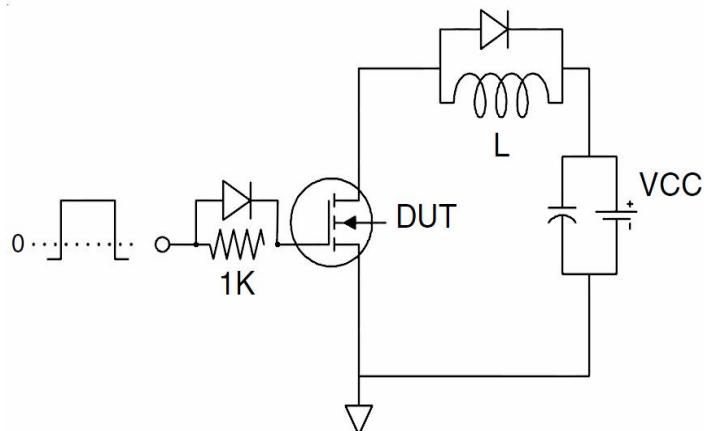
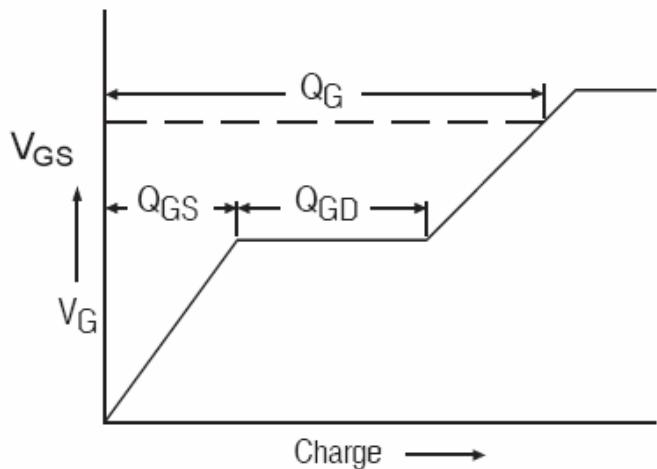
Figure7. Gate Charge

Figure8. Capacitance vs Vds

Figure9. Source- Drain Diode Forward

Figure10. Safe Operation Area

Figure11. Normalized Maximum Transient Thermal Impedance


Test Circuit

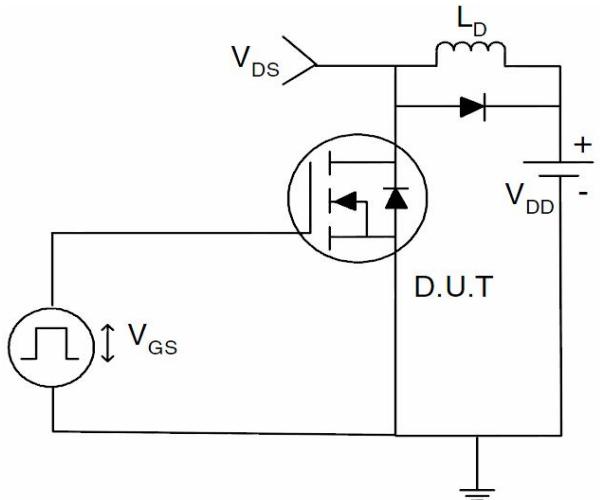
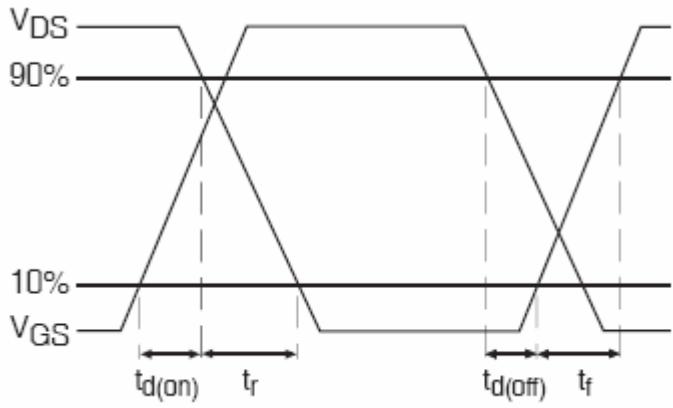
1) E_{AS} Test Circuits



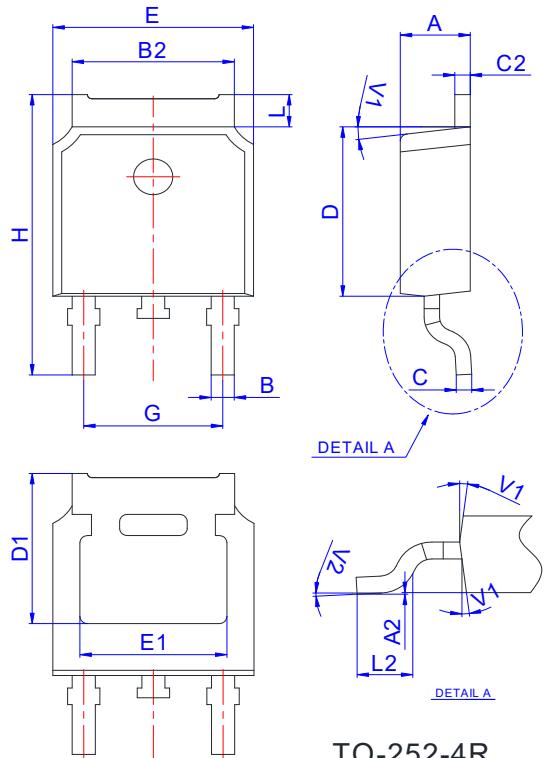
2) Gate Charge Test Circuit:



3) Switch Time Test Circuit:



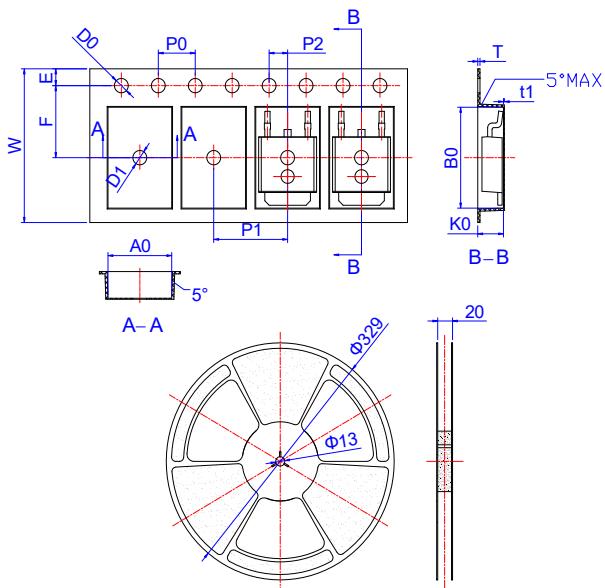
Package Mechanical Data-TO-252-4R



TO-252-4R

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Specification-TO-252-4R



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583